

Hexagon Application Kit

For XMC4000 Family

CPU_45B-V1
CPU Board XMC4500 SDRAM

Board User's Manual

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Microcontroller

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CPU_45B-V1 CPU Board XMC4500 SDRAM

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Overview

Introduction

This document describes the features and hardware details of the CPU board "CPU Board XMC4500 SDRAM" (CPU_45B-V1) designed to work with Infineon's XMC4500 Microcontroller. This board is part of Infineon's Hexagon Application Kits. Please visit www.infineon.com/xmc-dev for more information about the Hexagon Application Kit family.

1 Overview

The CPU board CPU_45B-V1 houses the XMC4500 Microcontroller and three satellite connectors (HMI, COM, ACT) for application expansion. The board along with satellite cards (e.g. HMI_OLED-V1, COM_ETH-V1, AUT_ISO-V1 boards) demonstrates the capabilities of XMC4500.

The main use case of this board is to demonstrate the external bus unit (EBU) of the XMC4500 device including the tool chain. For this purpose a 64 Mbit SDRAM is connected to the XMC4500 and for external bus extension an asynchronous 16-bit wide bus interface is available at the COM satellite connector.

Attention: This board (CPU_45B) has not been designed to work with the "General Purpose Motor Drive Card" (MOT_GPDLV). For this purpose please use the CPU boards CPU_45A, CPU_44A or CPU_42A.

The focus is safe operation under evaluation conditions. The board is neither cost nor size optimized and does not serve as a reference design.

1.1 Key Features

The CPU_45B-V1 board is equipped with the following features

- XMC4500 (ARM[®] Cortex™-M4-based) Microcontroller, 1 MByte Flash, 160 kByte SRAM, LFBGA-144
- 8 MByte On-board SDRAM, 1 Mbit x 16 bits x 4 banks
- Connection to satellite cards via satellite connectors COM, HMI and ACT
- USB OTG Host/Device support via micro USB connector
- Debug options
 - On-board Debugger via the Debug USB connector
 - Cortex Debug connector 10-pin (0.05")
 - Cortex Debug+ETM connector 20-pin (0.05")
- Reset push button
- 32 MBit quad SPI flash memory
- Boot option switch
- PowerScale Connector: Ready for power consumption analysis
- Two User Buttons connected to P5.10 and P0.10
- 7 LED's
 - 3 Power indicating LED's
 - 2 User LEDs (P5.2 and P1.1)
 - 1 RESET LED
 - 1 Debug LED
- Potentiometer, connected to analog input P14.1
- Power supply
 - Via Debug USB connector
 - Via Micro-USB connector in USB device mode
 - Via satellite connector pins (COM/ACT satellites cards can supply power to CPU board)
 - RTC backup battery



Overview

1.2 Block Diagram

Figure 1 shows the functional block diagram of the CPU_45B-V1 board. For more information about the power supply please refer to chapter 2.1.

The CPU board has got the following building blocks:

- 3 Satellite Connectors (COM, HMI ACT)
- 2 User LEDs connected to GPIOs P5.2 and P1.1
- 2 User Buttons connected to GPIOs P5.10 and P0.10.
- Quad SPI flash memory (32 Mbit)
- Synchronous Dynamic RAM (SDRAM, 64Mbit)
- 2 Cortex Debug Connectors
- Variable resistor (POTI) connected to GPIO P14.1
- USB On-The-Go Connector (Micro-USB)
- On-board Debugger via USB connector (Micro-USB)

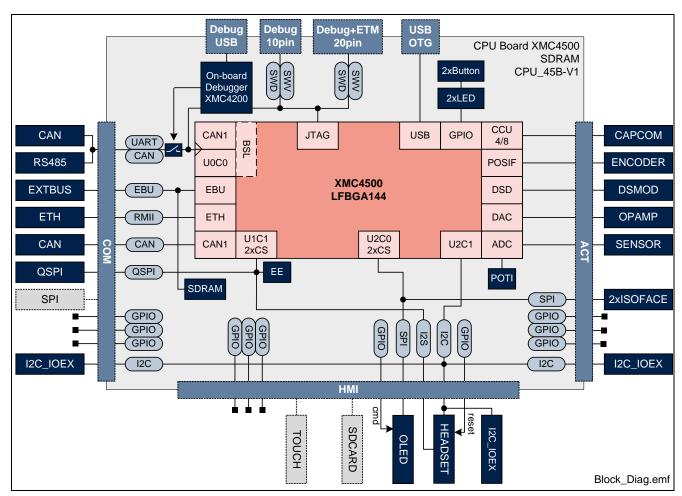


Figure 1 CPU_45B-V1 Board Block Diagram



2 Hardware Description

The following sections give a detailed description of the hardware and how it can be used.

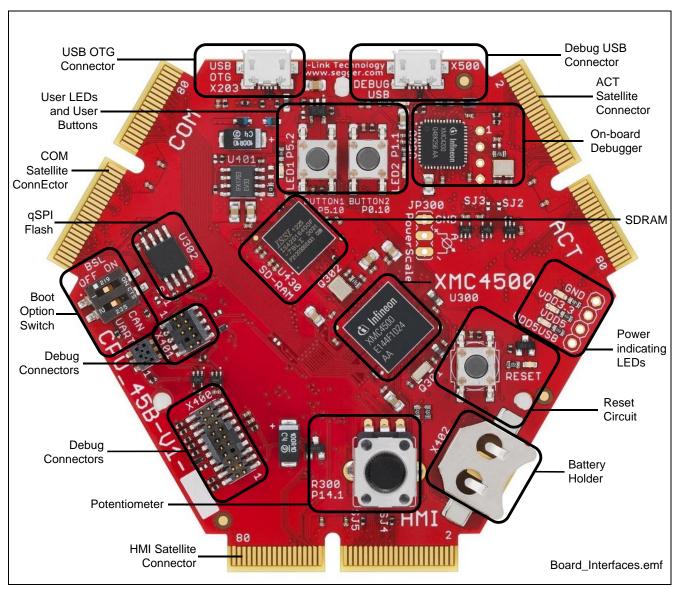


Figure 2 CPU Board XMC4500 SDRAM (CPU 45B-V1)

2.1 Power Supply

The CPU_45B-V1 board can be powered via either of the USB plugs (5 V); however, there is a current limit that can be drawn from the host PC through USB. If the CPU_45B-V1 board is used to drive other satellite cards (e.g. AUT_ISO-V1 or MOT_GPDLV-V2) and the total current required exceeds 500 mA, then the board needs to be powered by a satellite card, which supports external power supply like e.g. AUT_ISO-V1, MOT_GPDLV-V2, COM_ETH-V1.

The typical current drawn by the CPU board without any satellite cards connected is about 220 mA (@5V).

For powering the board through an USB interface, connect the USB cable provided with the kit to either of the Micro-USB connector on board as shown in Figure 3.



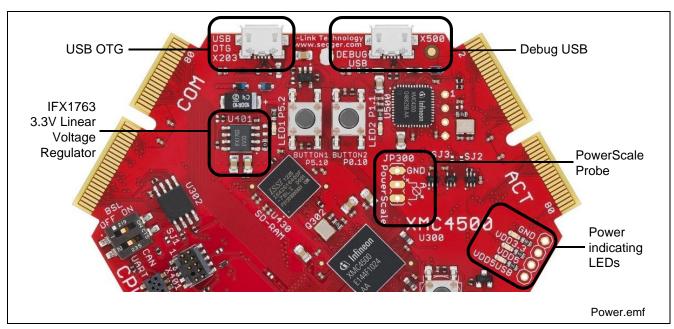
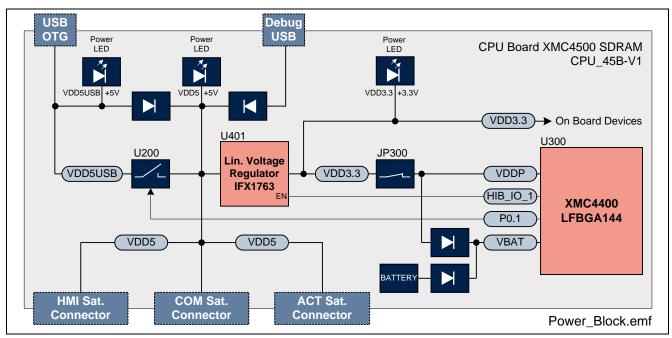


Figure 3 Powering option

To indicate the power status of CPU_45B-V1 board three power indicating LED's are provided on board (see Figure 3). The LED will be "ON" when the corresponding power rail is powered.

Table 1 Power status LEDs

LED Reference	Power Rail	Voltage	Note
V401	VDD5	5 V	Must always be "ON"
V402	VDD5USB	5 V	"ON" if powered by USB OTG connector X203 "OFF" in all other supply cases
V403	VDD3.3	3.3 V	Must always be "ON"



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Figure 4 Block Diagram Of Power Supply



CPU_45B-V1 CPU Board XMC4500 SDRAM

Hardware Description

Hitex PowerScale probe is provided on the CPU_45B-V1 board to measure the power consumption of the XMC4500 device.

Table 2 Power Measurement

Jumper	Function	Description
JP300	PowerScale	A Hitex PowerScale probe can be connected for current sensing the VDD3.3 (CPU power source). Default: pos. 1-2 (closed) Note: On the PCB there is a shorting trace between pin 1-2. This trace has to be cut first, before using PowerScale. Pin 3 is GND.



2.2 Reset

A reset signal connected to the low-active PORST# pin of the target CPU (U300) can be issued by

- an on-board Reset Button (SW400, RESET)
- an on-board debug device (U500)
- an external debugger connected to either Cortex Debug connector X400 or X401

The RESET signal is routed to all satellite connectors. The reset circuit includes a red LED (V407) to indicate the reset status: The Reset LED (V407) will be "ON" during active reset state and will be "OFF" if reset is not active.

Be aware that PORST# is a bidirectional reset pin of the XMC4000 family which can also be pulled low by the XMC4000 device itself.

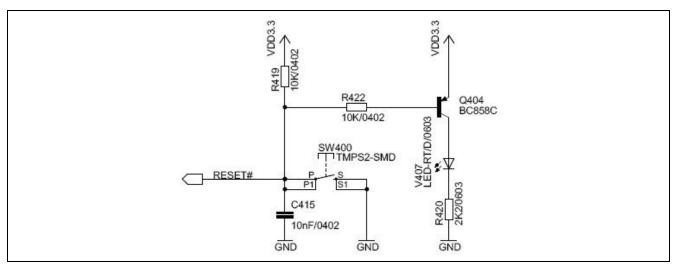


Figure 5 Reset Circuit



Figure 6 Reset LED and Reset Button



2.3 Clock Generation

An external 12 MHz crystal provides the clock signal to the XMC4500 microcontroller. The drive strength of the oscillator is set to maximum by software, in order to ensure a safe start-up of the oscillator even under worst case conditions. A serial 510 Ohm resistor will attenuate the oscillations during operations.

For the RTC clock a separate external 32.768 kHz crystal is used on board.

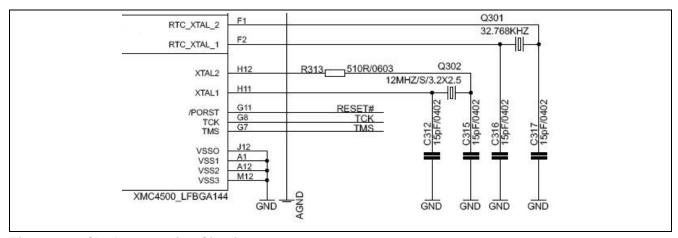


Figure 7 Clock Generation Circuit

2.4 Boot Option

During power-on-reset the XMC4500 latches the dip switch SW300 settings via the TCK and the TMS pin. Based on the values latched different boot options are possible.

Table 3 Boot Options Settings

BSL (TMS)	CAN/UART (TCK)	Boot Option
OFF (1)	UART (0)	Normal Mode (Boot from flash)
ON (0)	UART (0)	ASC BSL Enabled (Boot from UART)
OFF (1)	CAN (1)	BMI Customized Boot Enabled
ON (0)	CAN (1)	CAN BSL Enabled (Boot from CAN)

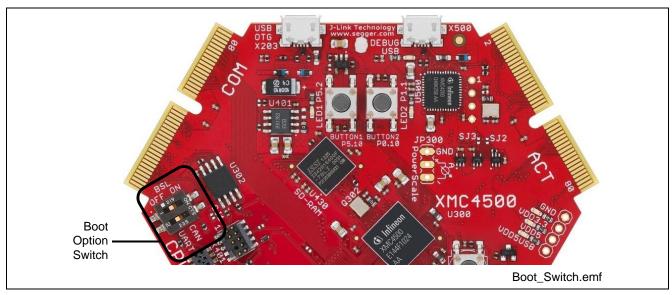


Figure 8 Boot Options Switch



CPU_45B-V1 CPU Board XMC4500 SDRAM

Hardware Description

2.5 Debug Interface

The CPU_45B-V1 board supports debugging via 3 different channels:

- On-board Debugger
- Cortex Debug Connector (10-pin)
- Cortex Debug+ETM Connector (20-pin)

The Hexagon Application Boards are designed to use "Serial Wire Debug" as debug interface. JTAG debug is not supported by default because the GPIO P0.7, where the required TDI function is mapped to also, is used by the on-board SDRAM device and various Actuator boards connected to the ACT satellite connector.

Attention: It is strongly recommended not to use JTAG debug mode, especially if satellites boards are connected, which uses the GPIO 0.7. For the same reason also do not use the on-board debugger in JTAG mode.

If you want to use the JTAG debug mode through the cortex debug connectors (X400, X401) anyway, enable the JTAG interface of the XMC device by assembling the pull-up resistor R427 (4k7 Ohm) and the resistor R410 (0 - 33 Ohm).



2.5.1 On-board USB Debugger

The on-board debugger [1] supports

- Serial Wire Debug
- Serial Wire Viewer [2]
- Full Duplex UART communication via a USB Virtual COM
- [1] Newer firmware versions of the on-board debugger require the latest J-Link driver (V4.62 or higher) and a Serial Port Driver (CDC driver) installed on your computer. Please check "Install J-Link Serial Port Driver" when installing the latest J-Link driver (see Figure 9)
- [2] Serial Wire Viewer operation does not work during use of the on-board SDRAM.

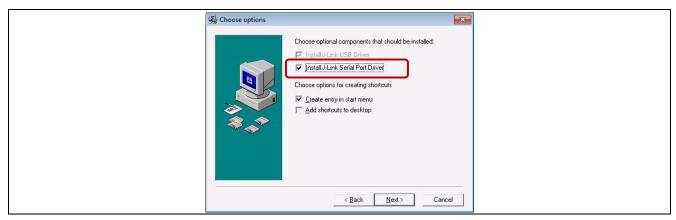


Figure 9 Installation of Serial Port Driver

The on-board debugger can be accessed through the Debug USB connector shown in Figure 10. The Debug LED V502 shows the status during debugging.

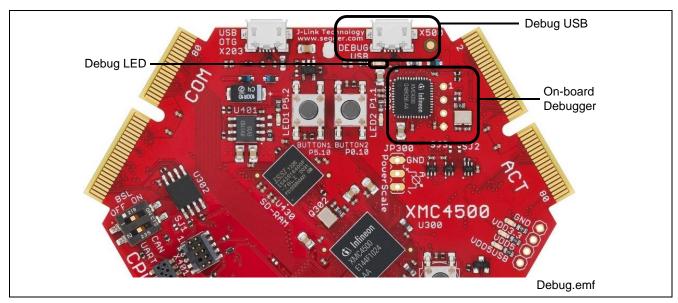


Figure 10 On-Board USB Debugger

When using an external debugger connected to the 10pin/20pin Cortex Debug Connector, the on-board debugger is switched off.

When using the USB virtual COM port function of the on-board debugger (connected to P1.4 and P1.5 of the XMC4500) the UART interface to the COM satellite is disabled through the switches U301 and U306.



2.5.2 Cortex Debug Connector (10-pin)

The CPU_45B-V1 board supports Serial Wire Debug operation through the 10-pin Cortex Debug Connector.

By default the board does not support Serial Wire Viewer operation through the 10-pin Cortex Debug Connector, because the required SWO pin mapped to P2.1 is used for the connection to the on-board SDRAM. If Serial Wire Viewer operation is required anyway the resistor R404 needs to be assembled.

JTAG operation additionally would require the TDI (P0.7) signal. By default the TDI signal is disconnected from the Cortex Debug Connectors by a not assembled resistor R410, because the pin P0.7 can be used by the onboard SDRAM, by Actuator boards connected to the ACT satellite connector and by boards connected to the COM satellite connector.

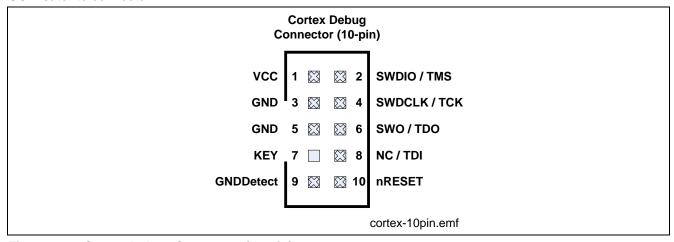


Figure 11 Cortex Debug Connector (10-pin)

Table 4 Cortex Debug Connector (10 Pin)

Pin No.	Signal Name	Serial Wire Debug	JTAG Debug
1	VCC	+3.3 V	+3.3 V
2	SWDIO / TMS	Serial Wire Data I/O	Test Mode Select
3	GND	Ground	Ground
4	SWDCLK / TCK	Serial Wire Clock	Test Clock
5	GND	Ground	Ground
6	SWO / TDO	Trace Data OUT	Test Data OUT
7	KEY	KEY	KEY
8	NC / TDI	Not connected	Test Data IN
9	GNDDetect	Ground Detect	Ground Detect
10	nRESET	Reset (Active Low)	Reset (Active Low)





Figure 12 Cortex Debug Connector (10-pin) Layout

2.5.3 Cortex Debug+ETM Connector (20-pin)

The CPU_45B-V1 board supports Serial Wire Debug operation and Instruction Trace operation through the 20-pin Cortex Debug+ETM Connector.

The board does not support Serial Wire Viewer operation through the Cortex Debug Connectors by default, because the required SWO pin mapped to P2.1 is used for the connection to the on-board SDRAM. If Serial Wire Viewer operation is required anyway the resistor R404 needs to be assembled.

JTAG operation additionally would require the TDI (P0.7) signal. By default the TDI signal is disconnected from the Cortex Debug Connectors by a not assembled resistor R410, because the pin P0.7 can be used by the onboard SDRAM, by Actuator boards connected to the ACT satellite connector and by boards connected to the COM satellite connector.

Cortex Debug+ETM Connector (20-pin)				
vcc	1 [2	SWDIO / TMS
GND	3 [4	SWDCLK / TCK
GND	5		6	SWO / TDO / EXTa / TRACECTL (NC)
KEY	7 [8	NC/EXTb/TDI (NC)
GNDDetect	9		10	nRESET
GND/TgtPwr+Cap	11		12	TRACECLK
GND/TgtPwr+Cap	13 [14	TRACEDATA[0]
GND	15		16	TRACEDATA[1]
GND	17 [18	TRACEDATA[2]
GND	19 [20	TRACEDATA[3]
				cortex-20pin.emf

Figure 13 Cortex Debug+ETM Connector (20-pin)



Table 5 Cortex Debug+ETM Connector (20 Pin)

Pin No.	Signal Name	Serial Wire Debug	JTAG Debug
1	VCC	+3.3 V	+3.3 V
2	SWDIO / TMS	Serial Wire Data I/O	Test Mode Select
3	GND	Ground	Ground
4	SWDCLK / TCK	Serial Wire Clock	Test Clock
5	GND	Ground	Ground
6	SWO/TDO	Trace Data OUT	Test Data OUT
7	KEY	KEY	KEY
8	NC / TDI	Not connected	Test Data IN
9	GNDDetect	Ground Detect	Ground Detect
10	nRESET	Reset (Active Low)	Reset (Active Low)
11	GND/TgtPwr+Cap	Ground	Ground
12	TRACECLK	Trace Clock	Trace Clock
13	GND/TgtPwr+Cap	Ground	Ground
14	TRACEDATA[0]	Trace Data 0	Trace Data 0
15	GND	Ground	Ground
16	TRACEDATA[1]	Trace Data 1	Trace Data 1
17	GND	Ground	Ground
18	TRACEDATA[2]	Trace Data 2	Trace Data 2
19	GND	Ground	Ground
20	TRACEDATA[3]	Trace Data 3	Trace Data 3



Figure 14 Cortex Debug+ETM Connector (20-pin) Layout



2.6 Serial Flash Memory

The CPU_45B-V1 board has 32Mbit serial flash memory interfaced to XMC4500 through a SPI interface. The SPI interface can be configured as single, dual or quad SPI.

Table 6 Quad SPI Signals

Pin No.	Signal Name	Signal Description
P0.13	CLK	Clock
P3.3	CS#	Active Low Chip Select
P3.15	DI	Data Input of Flash (MTSR)
P3.14	DO	Data Output of Flash (MRST)
P0.14	Data I/O	Data Input/Output
P0.15	Data I/O	Data Input/Output

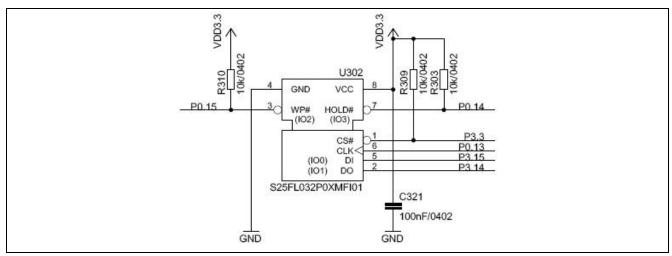


Figure 15 Quad SPI Flash Interface



2.7 SDRAM

The CPU_45B-V1 board has a 64 Mbit SDRAM interfaced to the XMC4500. The SDRAM interface is shown in Figure 16.

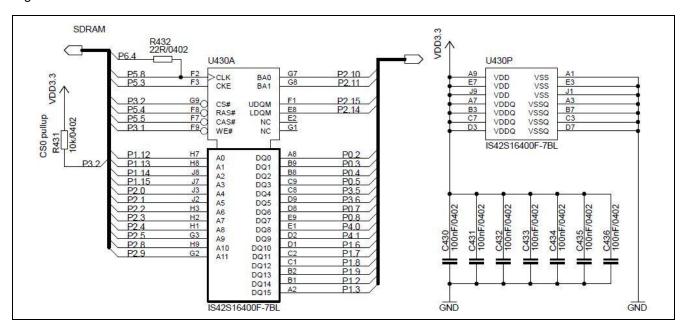


Figure 16 SDRAM Interface

2.8 USB

The XMC4500 supports USB interface in host only mode, device only mode or as an OTG Dual Role Device (DRD). In USB device mode, power is expected through VBUS (pin 1 of X203) from an external host (e.g. PC).

When the current consumption of the application running on the Hexagon Application system is higher than 500 mA, power from an external source through satellite cards shall be used.

Note: Some PCs, notebooks or hubs have a weak USB supply which is not sufficient for proper supply. In this case use an external 5 Volt power supply or a powered USB hub.

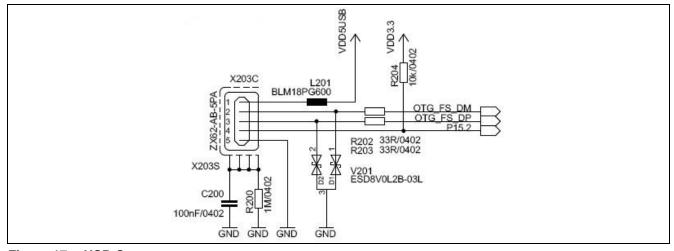


Figure 17 USB Connector

The USB ID pin of the USB connector is connected to the port pin P15.2 of the XMC4500. This pin must be polled by software, because this pin does not support USB_ID detection.

An OTG device will detect whether a USB 3.0 Micro-A or Micro-B plug is inserted by checking the ID pin. When the ID = FALSE, Micro-A connector is plugged and when ID = TRUE a Micro-B connector is plugged in. When ID is true the XMC4500 acts as USB host else as USB device.



Table 7 USB micro AB connector Pinout

Pin No.	Pin Name	Pin Description
1	VBUS	5 V
2	D-	Data Minus
3	D+	Data Plus
4	ID	Identification
5	GND	Ground

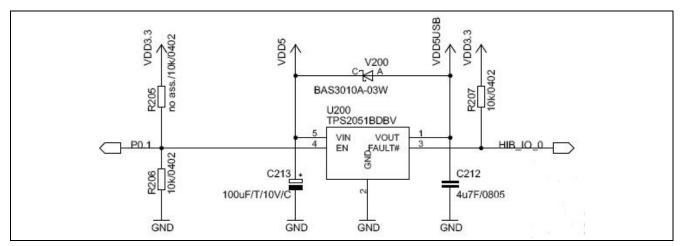


Figure 18 USB power generation - Host/OTG mode

In the host only mode and OTG mode the CPU_45B-V1 board is capable of supplying power to the connected device (e.g. USB mouse). The board has a power-switch which is controlled by the USB.BUSDRIVE signal of XMC4500. USB.BUSDRIVE is mapped to Port P0.1 (active high).

In the Host/OTG mode a low active FAULT signal indicates to XMC4500 via HIB_IO_0 signal, if more than 500 mA current is drawn by the external device. HIB_IO_0 signal is used as general purpose input pin for this implementation.

Diode V200 will allow powering the board through USB in all USB modes via e.g. a PC.



2.9 RTC

The XMC4500 CPU has two power domains, the Core Domain and Hibernate Domain.

The Core Domain (VDDP pins) is connected to the VDD3.3 rail. An on-board LDO voltage regulator generates VDD3.3 (3.3 V) from VDD5 (5 V).

The Hibernate Domain is powered via the auxiliary supply pin VBAT, which is supplied by either a 3 V coin cell (size 1216, 1220, 1225) plugged into the battery holder or 3.3 V (VDD3.3) generated by the on-board voltage regulator.



Figure 19 Battery Holder for Coin Cells

The Real Time Clock (RTC) is located in the hibernate domain. The XMC4500 uses the HIB_IO_1 signal (active low) to shutdown the external LDO voltage regulator which generates VDD3.3 (core domain). Even if the Core Domain is not powered the Hibernate Domain will operate if VBAT is available. The RTC keeps running as long as the Hibernate Domain is powered via the auxiliary supply VBAT. The RTC is capable to wake-up the whole system from Hibernate mode by setting HIB_IO_1 to high.

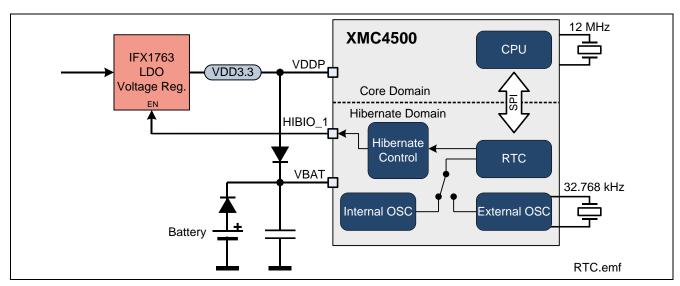


Figure 20 XMC4500 Power Domains and Real Time Clock



2.10 User LEDs and User Button

The port pins P5.2 and P1.1 of XMC4500 on the CPU_45B-V1 board are connected to the LEDs V300 and V301 respectively. More User LED's are available through the I2C GPIO expander on most of the satellite cards.

Table 8 User LEDs

LED	Connected to Port Pin
LED1 / V300	GPIO P5.2
LED2 / V301	GPIO P1.1

Two User Buttons, SW401 and SW402 are connected to P5.10 and P0.10 of XMC4500

Table 9 User Buttons

Button	Connected to Port Pin
Button1 / SW401	GPIO P5.10
Button2 / SW402	GPIO P0.10

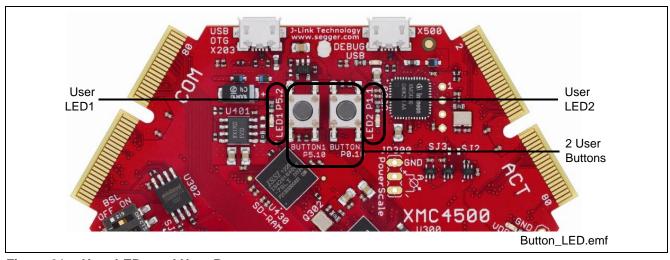


Figure 21 User LEDs and User Buttons

2.11 Potentiometer

The CPU_45B-V1 board provides a potentiometer for ease of use and testing of the on-chip analog to digital converter. The potentiometer is connected to the analog input G0_CH1 (P14.1). The analog output of the potentiometer ranges from 0 V to 3.3 V.

Table 10 Potentiometer

Potentiometer	Connected to Port Pin
R300	P14.1/ G0_CH1 (Group 0, channel 1)



2.12 Satellite Connectors

The CPU_45B-V1 board provides three satellite connectors for application expansion by satellite cards:

- COM satellite connector (Communication)
- HMI satellite connector (Human Machine Interface)
- ACT satellite connector (Actuator)

Note: Satellite cards shall be connected to their matching connectors only. (For e.g. COM satellite cards shall be connected to COM satellite connector only)

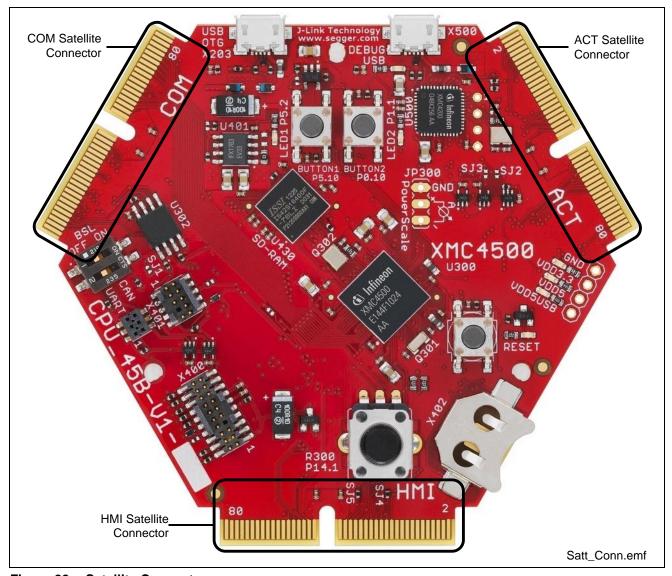


Figure 22 Satellite Connectors



2.12.1 COM Connector

The COM satellite connector on the CPU_45B-V1 board allows interface expansion through COM satellite cards (e.g. COM_ETH-V1)

	XMC Pin		NSS	P3.15	P3.14	P0.15	P0.14	nc	P2.13	P2.12	P15.9	P15.8	VSS	nc	P2.7	P2.6	nc	nc	nc	P3.13	P6.3	PORST			P0.2	P0.3	P0.4	P0.5	P3.5	P3.6	P0.7	P0.8	P4.0	P4.1	P1.6	P1.7	P1.8	P1.9	P1.2	P1.3	NSS
CPU_45B-V1 (SDRAM)	XMC Function		GND	U1C1_DOUT0	U1C1_DOUT1	U1C1_DOUT2	U1C1_DOUT3	nc	ETHO_TXD1	ETHO_TXD0	ETHO_CRS_DVC	ETHO CLK RMIIC	DND	nc Cu	CAN_N1_TXD	CAN_N1_RXDA	nc	nc		U2C1_SCLKOUT	P6.3	RESET#			EBU_AD0		EBU_AD2	EBU_AD3	EBU_AD4	EBU_AD5	EBU_AD6	EBU_AD7	EBU_AD8	EBU_AD9	EBU_AD10	EBU_AD11	EBU_AD12	EBU_AD13	EBU_AD14	EBU_AD15	GND
	Function		GND	dSPI_D0	qSPI_D1	qSPI_D2	qSPI_D3	RSVD	ETH_RMII	ETH_RMII	ETH_RMII	ETH RMII	GND	RSVD	CAN_TXD	CAN_RXD	SPI_MTSR	SPI_MRST	SPI_SCLK	12C_SCL	GPIO	RESET	VDDS	VDD5	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	EBU_AD	GND
Satellite	Pin	сом	2	4	6	8	10	12	14	16	18 2	0 22	2 24	1 26	28	30	32	34	36	38	40 4	42	44	₩ 4 9 4	5 48	50	52	54	56	58	60	62	64	66	68	70	72	74	76 7	78 8	30
Connector	- E	8	1	3	5	7	9	11	13	15	17 1	9 2:	1 23	3 25	27	29	31	33	35	37	39	41	43	8 4	5 47	49	51	53	55	57	59	61	63	65	67	69	71	73	75 7	77	79
	Function		GND	qSPI_SCLK	qSPI_CS	qSPI_CS	RSVD	RSVD	ETH_RMII	ETH_RMII	ETH_RMII	ETH RMII	RSVD	ASC DIR	ASC_RXD	ASC_TXD	SPI_CSC0	SPI_CSC1	SPI_CSC2	I2C_SDA	COM_GPI01	COM_GPI00	VDD5	VDDS	EBU_ADV	EBU_WR	EBU_RD	EBU_BC	EBU_BC	EBU_CS	EBU_CS	GND	EBU_A	EBU_A	EBU_A	EBU_A	EBU_A	EBU_A	EBU_A	EBU_A	GND
CPU_45B-V1 (SDRAM)	XMC Function		GND	U1C1_SCLKOUT	U1C1_SELO0	U1C1_SELO1	nc	nc	ETHO_RXD1D	ETHO_RXD0D	ETHO_MDO	ETHO TX FN	nc	nc	UOCO_DX0B	посо_роито	nc	nc		U2C1_DOUT0/DX0D	P14.13	P0.0			EBU.nADV	EBU_RD/EBU_nWR	EBU_RD	EBU_nBC1	EBU_nBC0	nc	EBU_nCS1	GND	nc	nc	nc	nc	EBU_A19	EBU_A18	EBU_A17	EBU_A16	GND
	XMCPin		NSS	P0.13	P0.12	P3.3 *	nc	nc	P5.1	P5.0	P1.11	P5.9	2	ou.	P1.4 **	P1.5 **	nc	nc	nc	P3.11/P3.12	P14.13	P0.0			P0.6	P3.1	P3.0	P2.15	P2.14	nc	P0.9	NSS	nc	nc	nc	nc	P6.4	P6.2	P6.1	P6.0	VSS

Figure 23 Satellite Connector Type COM

Attention: * This pin is used as chip select signal for the on-board EEPROM and therefore disconnected by solder jumper SJ1

Attention: ** This pin is connected with the satellite connector via an analog switch



2.12.2 HMI Connector

The HMI satellite connector on the CPU_45B-V1 board allows interface expansion through HMI satellite cards.

	XMC Pin		NSS	nc	nc	nc	nc	nc	nc	nc	nc	nc	nc	P5.11	P3.15	P3.14	P3.8	P3.7	P3.9	P3.13	P6.3	POSRT			VAREF	P14.8	P14.4	P14.3	P15.3	ou c) L	2 24	nc	NSS						
CPU_45B-V1 (SDRAM)	XMCFunction		GND	nc	nc	nc	nc	nc	nc	nc	nc	nc	nc	P5.11	U1C1.DOUTO	U1C1.SCIKOUT	U2C0.DOUT0	U2C0.DX0C	U2C0.SCLKOUT	U2C1.SCLKOUT	P6.3	RESET#			VAREF	VADC_G1CH0	VADC_G0CH4	VADC_G0CH3	VADC_G2CH3	DU C	= =	n on	nc	GND						
	Function		GND	MMC_nRST	MMC_DATA0	MMC_DATA2	MMC_DATA4	MMC_DATA6	MMC_CMD	MMC_LED	MMC_SDWC	RSVD	RSVD	OLED_CMD	IZS_MISK	125 SCLK	SPI MTSR	SPI_MRST	SPI_SCLK	12C_SCL	GPIO	RESET	VDDS	VDDS	AREF	DAC1/ADC0	ADC2/DACREF	ADC14	ADC16	ADC18	RSVD	TP7	TP6	TP5	TP4	ТРЗ	TP2	TP1	TPO	GND
Satellite	Pin	IΜH	2	4	6	8	10	12	14	16	18	20	22 2	24 2	26 2	8 30	32	34	36	38	40	42	44 43	46	48	50	52	54	56 5	8 6	0 6	2 64	66	68	70	72	74	76	78	80
Connector		Ī	1	3	5	7	9	11	13	15	17	19	21 2	23 2	25 2	7 29	31	. 33	35	37	39	41	43	45	47	49	51	53	55 5	57 5	9 6	1 63	65	67	69	71	73	75	77	79
	Function		GND	MMC_CLK	MMC_DATA1	MMC_DATA3	MMC_DATA5	MMC_DATA7	MMC_BUSPOW	MMC_nSDCD	RSVD	RSVD	RSVD	AudioKSI	125_WA	125 SYNCLK	SPI CSH0	SPI_CSH1	SPI_CSH2	I2C_SDA	HMI_GPI01	HMI_GPIO0	VDDS	VDD5	AGND	DAC0/ADC1	ADC3/ORC0	ADC15	ADC17	ADCIB	RSVD	RSVD	TPx1	TPx0	COL3	COL2	COL1	COLO	COLA	GND
CPU_45B-V1 (SDRAM)	XMC Function		GND	nc	nc	nc	nc	nc	nc	nc	nc	nc	nc		U1C1.SELO2	nc nc	U2C0.SELO0	U2C0.SELO3	nc	U2C1_DOUT0/DX0D	P15.5 Input	P5.7			AGND	DAC.OUT1	nc	VADC_G1CH4	VADC_G3CH5	VADC_G3CH4) IC	nc	GND							
	XMC Pin		NSS	nc	nc	nc	nc	nc	nc	nc	nc	nc	о . С	P4.2	P3.4	2 2	P3.10	P5.6	nc	P3.11/P3.12	P15.5	P5.7			VAGND	P14.9	nc	P14.12	P15.13	P15.12	2 2	2	υC	nc	nc	nc	nc	nc	nc	VSS

Figure 24 Satellite Connector Type HMI



2.12.3 ACT Satellite Connector

The ACT satellite connector on the CPU_45B-V1 board allows interface expansion through ACT satellite cards.

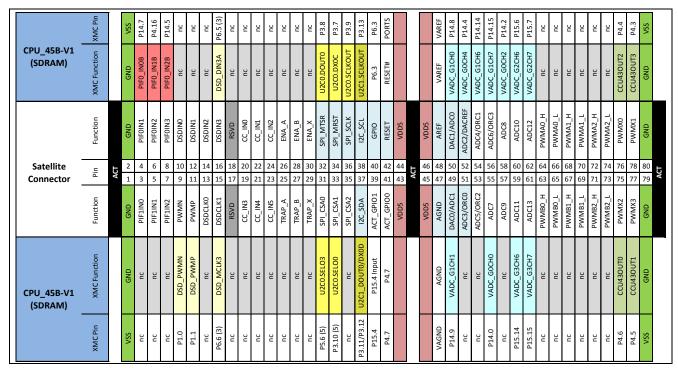


Figure 25 Satellite Connector Type ACT

- (1) P0.7 can also be used for JTAG Debugging (TDI)
- (2) P0.8 is used as TRST in order to enable JTAG Debug
- (3) This pin is connected with the satellite connector via an analog switch
- (4) This ADC input does not support "Out of Range Detection"
- (5) This pin is disconnected by a solder jumper
- (6) Support High Resolution PWM

3 Production Data

3.1 Schematics

This chapter contains the schematics for the CPU board:

- Satellite Connectors, USB-OTG
- XMC4500
- Power, Debug Connector, Reset
- On-board Debugger

The board has been designed with Eagle. The full PCB design data of this board can also be downloaded from www.infineon.com/xmc-dev.



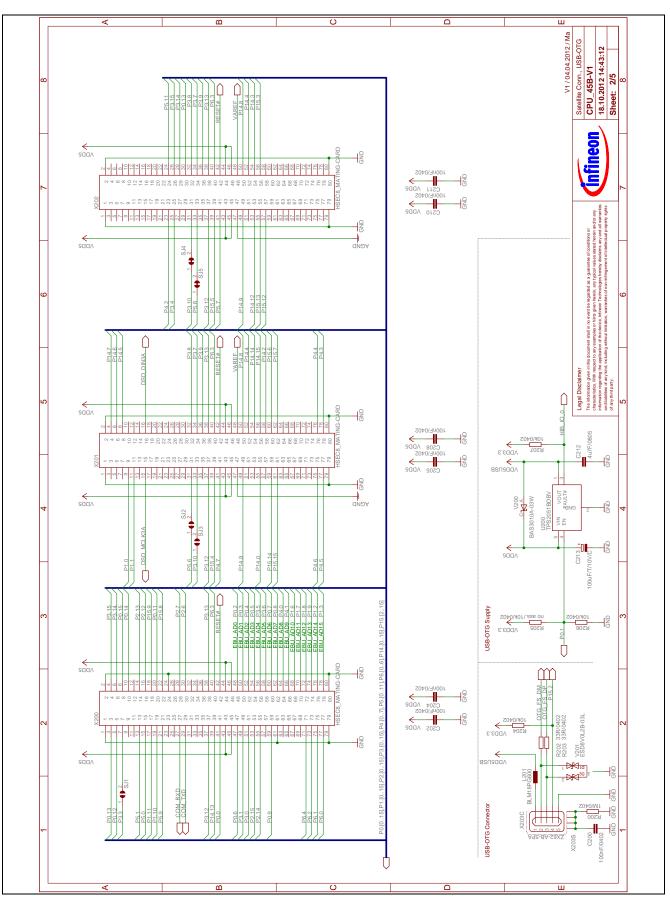


Figure 26 Satellite Connectors, USB-OTG



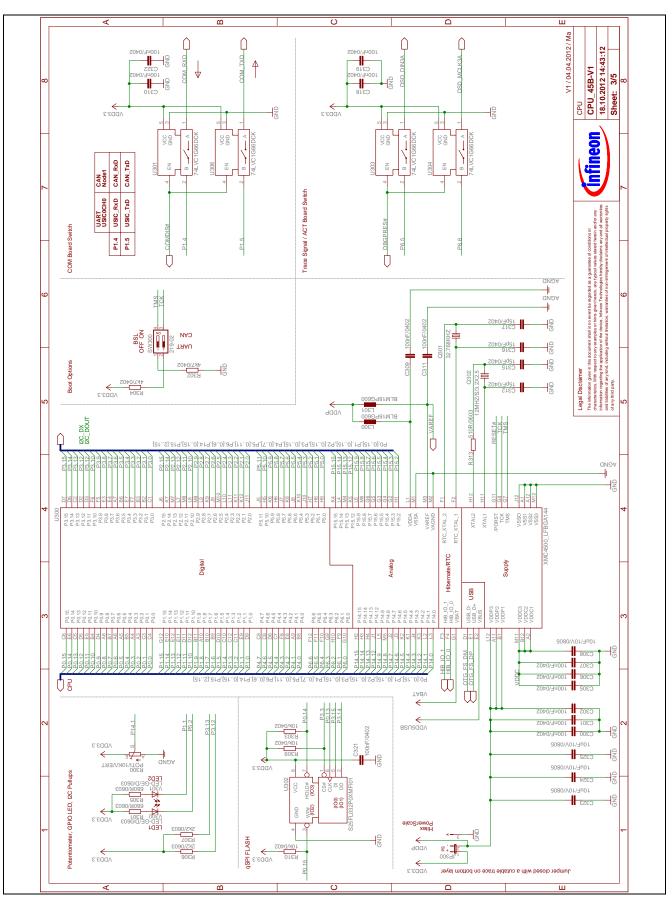


Figure 27 XMC4500



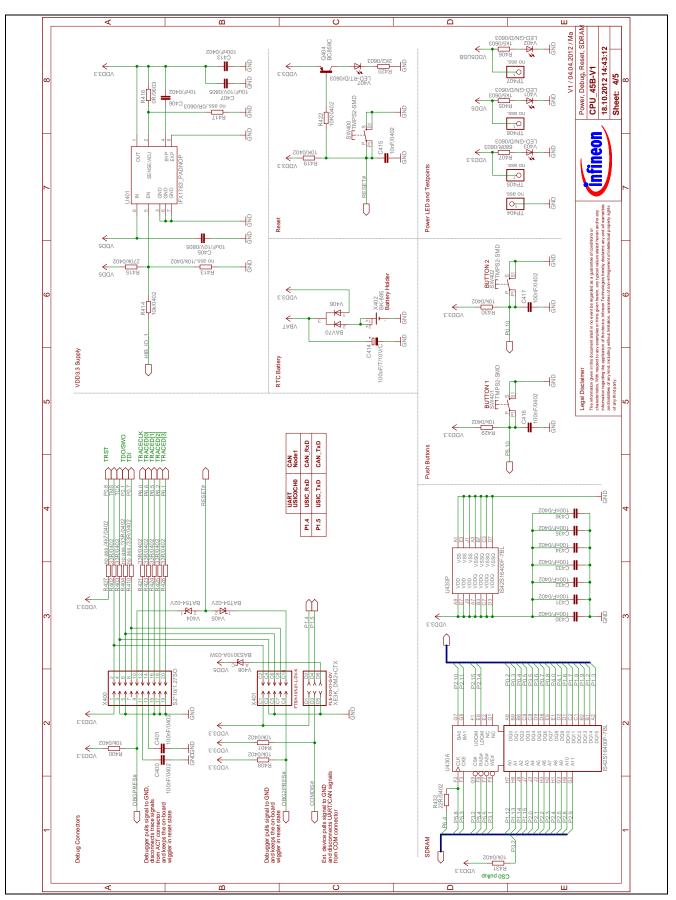


Figure 28 Power, Debug Connector, Reset, SDRAM



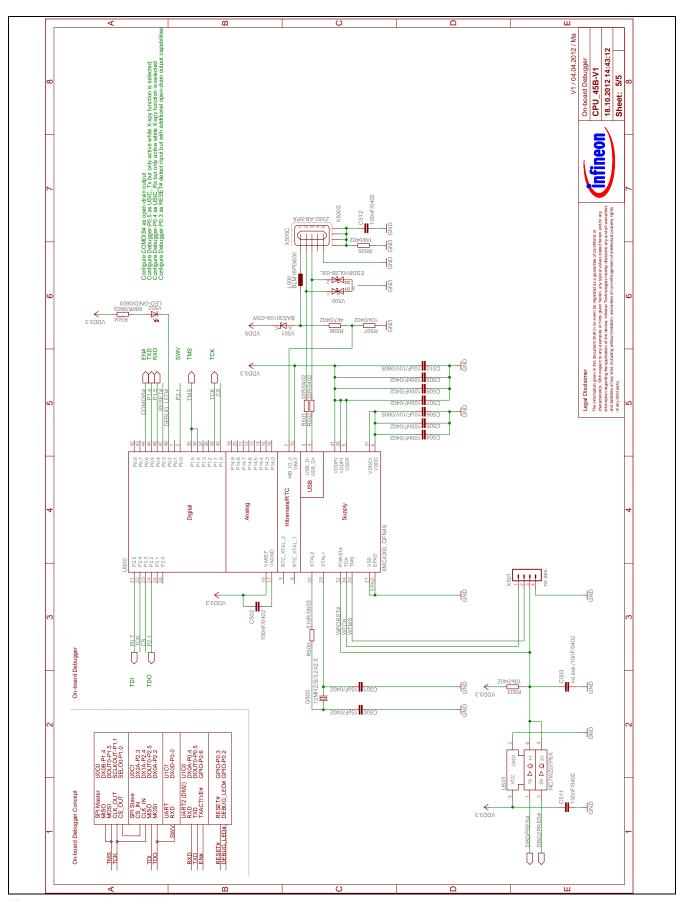


Figure 29 On-board Debugger

3.2 Component Placement and Geometry

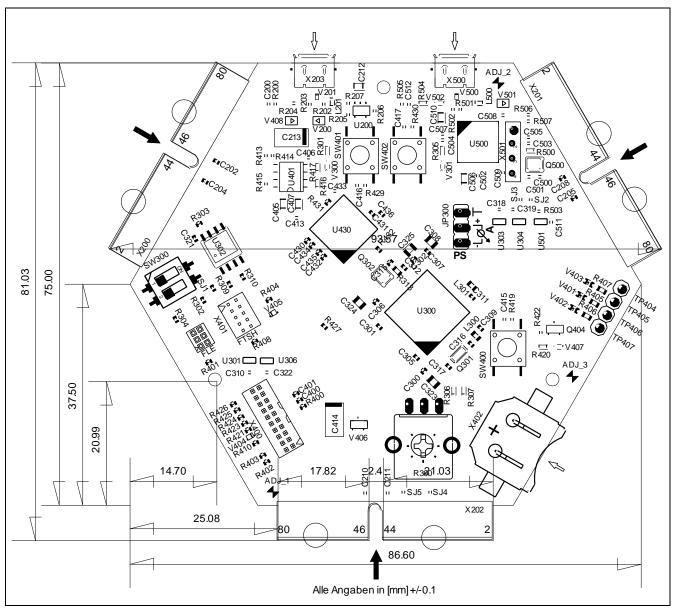


Figure 30 Component Placement and Geometry

CPU_45B-V1 CPU Board XMC4500 SDRAM

Production Data

3.3 Bill of Material (BOM)

Table 11 BOM of CPU_45B-V1 Board

Pos No.	Qty	Value	Device	Reference Des.
1	1	0R/0603	Resistor	R416
2	2	1M/0402	Resistor	R200, R505
3	2	1k5/0603	Resistor	R405, R406
4	3	2k2/0603	Resistor	R306, R307, R420
5	3	4k7/0402	Resistor	R302, R304, R506
6	1	4u7F/0805	Capacitor, ceramic	C212
7	17	10k/0402	Resistor	R204, R206, R207, R303, R309, R310, R400, R401, R408, R414, R419, R422, R429, R430, R431, R503, R507
8	2	10nF/0402	Capacitor	C406, C415
9	8	10uF/10V/0805	Capacitor, ceramic	C308, C323, C324, C325, C405, C407, C506, C510
10	2	12MHZ/S/3.2X2.5	Crystal, NX3225GD, NDK	Q302, Q500
11	6	15pF/0402	Capacitor	C312, C315, C316, C317,C500, C501
12	1	22R/0402	Resistor	R432
13	1	32.768KHZ	Crystal, NX3215SA, NDK	Q301
14	11	33R/0402	Resistor	R202, R203, R402, R403, R421, R423, R424, R425, R426, R501, R502
15	4	74LVC1G66DCK	IC, Single Analog Switch	U301, U303, U304, U306
16	40	100nF/0402	Capacitor	C200, C202, C204, C205, C208, C210, C211, C300, C301, C302, C305, C306, C307, C309, C310, C311, C318, C319, C321, C322, C413, C416, C417, C430, C431, C432, C433, C434, C435, C436, C400, C401, C502, C504, C505, C507, C508, C509, C511, C512
17	2	100uF/T/10V/C	Capacitor, bipolar	C213, C414
18	1	219-02	Dual DIP-Switch, 0.1" SMD	SW300
19	1	270k/0402	Resistor	R415
20	2	510R/0603	Resistor	R313, R500
21	4	680R/0603	Resistor	R301, R305, R407, R504
22	3	BAS3010A-03W	Diode, SOD323, Infineon	V200, V408, V501
23	2	BAT54-02V	Diode, SC79, Infineon	V404, V405
24	1	BAV70	Diode, SOT23-3, Infineon	V406
25	1	BC858C	Transistor, SOT23-3, Infineon	Q404
_				



CPU_45B-V1 CPU Board XMC4500 SDRAM

26	1	BK-885	Battery Holder, 12mm Coin Cell	X402
27	4	BLM18PG600	Ferrite Bead, 0603, Murata	L201, L300, L301, L500
28	2	ESD8V0L2B-03L	Diode, TSLP-3-1, Infineon	V201, V500
29	3	HSEC8_MATING-CARD	Connector, Edgecard, Samtec	X200, X201, X202
30	1	IFX1763_PADNOP	Voltage Regulator, 3.3V LDO, Infineon	U401
31	2	LED-GE/D/0603	LED, yellow	V300, V301
32	4	LED-GN/D/0603	LED, green	V401, V402, V403, V502
33	1	LED-RT/D/0603	LED, red	V407
34	1	IS42S16400F-7BL	Synchronous Dynamic RAM, ISSI	U430
35	1	NC7WZ07P6X	IC, Dual Buffer OD, SC70-6	U501
36	1	POTI/10K/VERT	Potentiometer, K09K1130A8G, ALPS	R300
37	1	S2*10/1.27SO	Connector, FTSH-110-01-L- DV-K-P, Samtec	X400
38	1	S25FL032P0XMFI01	IC, qSPI Flash Memory, SPANSION	U302
39	3	TMPS2-SMD	Switch, tactile	SW400, SW401, SW402
40	1	TPS2051BDBV	IC, Power Switch, SOT23-5	U200
41	1	XE3K_DM2+CTX	Connector, FTSH-105-01-LM-DV-K, w/o pin 7, Samtec Connector, FLE-103-01-G-DV, Samtec	X401
42	1	XMC4200_QFN48	IC, XMC4200, QFN48, Infineon	U500
43	1	XMC4500_LFBGA144	IC, XMC4500, LFBGA144, Infineon	U300
44	2	ZX62-AB-5PA	Connector, Micro-USB, Hirose	X203, X500
45	1	no ass.	Pinheader, 4-pin, 0.1" TH	X501
46	4	no ass.	Pinheader, 1-pin, 0.1" TH	TP404, TP405, TP406, TP407
47	1	no ass./0R/0603	Resistor	R417
48	1	no ass./4k7/0402	Resistor	R427
49	2	no ass./10k/0402	Resistor	R205, R413
50	1	no ass./10nF/0402	Capacitor	C503
51	2	no ass./33R/0402	Resistor	R404, R410
52	1	no ass.	Pinheader, 3-pin, 0.1" TH, Hitex PowerScale	JP300
53	3	no ass.	Solder Bridge (open)	SJ1, SJ2, SJ3
54	2	0R/0402	Solder Bridge (closed by resistor)	SJ4, SJ5

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